B-Suffix Series CMOS Gates MC14001B, MC14011B, MC14023B, MC14025B, MC14071B, MC14073B, MC14081B, MC14082B

The B Series logic gates are constructed with P and N channel enhancement mode devices in a single monolithic structure (Complementary MOS). Their primary use is where low power dissipation and/or high noise immunity is desired.

Features

- Supply Voltage Range = 3.0 Vdc to 18 Vdc
- All Outputs Buffered
- Capable of Driving Two Low–power TTL Loads or One Low–power Schottky TTL Load Over the Rated Temperature Range.
- Double Diode Protection on All Inputs Except: Triple Diode Protection on MC14011B and MC14081B
- Pin-for-Pin Replacements for Corresponding CD4000 Series B Suffix Devices
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (Voltages Referenced to V_{SS})

-			
Symbol	Parameter	Value	Unit
V _{DD}	DC Supply Voltage Range	-0.5 to +18.0	V
V _{in} , V _{out}	Input or Output Voltage Range (DC or Transient)	–0.5 to V _{DD} + 0.5	V
I _{in} , I _{out}	Input or Output Current (DC or Transient) per Pin	±10	mA
PD	Power Dissipation, per Package (Note 1)	500	mW
T _A	Ambient Temperature Range	-55 to +125	°C
T _{stg}	Storage Temperature Range	-65 to +150	°C
TL	Lead Temperature (8–Second Soldering)	260	°C
V _{ESD}	ESD Withstand Voltage Human Body Model Machine Model Charged Device Model	> 3000 > 300 N/A	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Temperature Derating: "D/DW" Packages: -7.0 mW/°C From 65°C To 125°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high–impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or $V_{DD}).$ Unused outputs must be left open.



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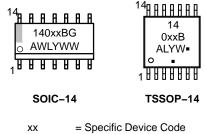
http://onsemi.com



D SUFFIX CASE 751A

TSSOP-14 DT SUFFIX CASE 948G

MARKING DIAGRAMS



А	= Assembly Location
WL, L	= Wafer Lot
YY, Y	= Year
WŴ, W	= Work Week
G or ■	= Pb-Free Package

(Note: Microdot may be in either location)

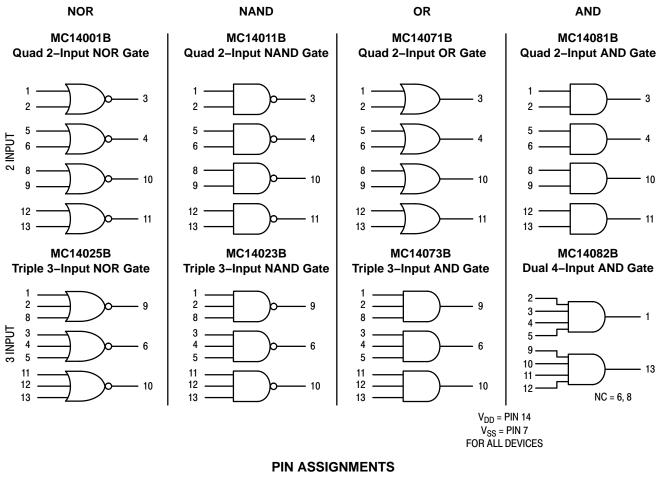
DEVICE INFORMATION

Device	Description
MC14001B	Quad 2–Input NOR Gate
MC14011B	Quad 2–Input NAND Gate
MC14023B	Triple 3–Input NAND Gate
MC14025B	Triple 3–Input NOR Gate
MC14071B	Quad 2–Input OR Gate
MC14073B	Triple 3–Input AND Gate
MC14081B	Quad 2–Input AND Gate
MC14082B	Dual 4–Input AND Gate

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

LOGIC DIAGRAMS



Quad	MC140 2–Input		Gate		MC14011B –Input NAI				4023B out NAN	D Gate	Triple		4025B out NOF	R Gate
in 1 _a E	1•	14 🛛 \	V _{DD}	in 1 _a [1• 14	D V _{DD}	in 1 _a C	1•	14] V _{DD}	IN 1 _A [1•	14] V _{DD}
IN 2 _A [2	13 🛛 I	IN 2 _D	IN 2 _A [2 13] IN 2 _D	IN 2 _A [2	13] IN 3 _C	IN 2 _A [2	13] IN 3 _C
OUT _A [3	12 🛛 I	IN 1 _D	OUT _A [3 12] IN 1 _D	IN 1 _B [3	12] IN 2 _C	IN 1 _B [3	12] IN 2 _C
out _b [4	11 🛛 🗘	OUT _D	out _b [4 11] OUT _D	IN 2 _B [4	11] IN 1 _C	IN 2 _B [4	11] IN 1 _C
IN 1 _b [5	10 🛛 (OUT _C	in 1 _b [5 10] оит _с	in 3 _b [5	10] OUT _C	in 3 _b [5	10] OUT _C
IN 2 _B [6	9 🛛 I	IN 2 _C	IN 2 _B [6 9] IN 2 _C	out _b [6	9] OUT _A	out _b [6	9] OUT _A
v _{ss} [7	8 🛛 I	IN 1 _C	v _{ss} C	7 8	IN 1 _C	v _{ss} C	7	8] IN 3 _A	v _{ss} C	7	8] IN 3 _A

	MC1407 2–Input		Gate	Triple	MC1 3–In
in 1 _a C	1•	14] v _{dd}	in 1 _a C	1•
IN 2 _A [2	13] IN 2 _D	IN 2 _A [2
out _a [3	12] IN 1 _D	IN 1 _B [3
out _b [4	11] OUT _D	IN 2 _B [4
IN 1 _b [5	10] оит _с	in 3 _b [5
IN 2 _B [6	9] IN 2 _C	out _b [6
v _{ss} [7	8] IN 1 _C	v _{ss} C	7

MC14073B Triple 3–Input AND Gate							
in 1 _a C	1●	14] v _{dd}				
IN 2 _A [2	13] IN 3 _C				
IN 1 _B [3	12] IN 2 _C				
IN 2 _B [4	11] IN 1 _C				
IN 3 _b [5	10] оит _с				
out _b [6	9] OUT _A				
v _{ss} [7	8] IN 3 _A				

MC14081B Quad 2–Input AND Gate						
Quad	z–inp		Gate			
in 1 _a C	1•	14	D V _{DD}			
IN 2 _A [2	13] IN 2 _D			
OUT _A [3	12] IN 1 _D			
out _b [4	11]ουτ _d			
in 1 _b [5	10	DOUT _C			
IN 2 _B [6	9] IN 2 _C			

8 I IN 1_C

V _{SS} L	1	8	
Dual 4	MC140 –Input		Gate
out _a [1●	14	D V _{DD}
IN 1 _A [2	13] OUT _B
IN 2 _A [3	12] IN 4 _B
IN 3 _A [4	11] IN 3 _B
in 4 _a E	5	10] IN 2 _B
NC [6	9] IN 1 _B
v _{ss} [7	8] NC

NC = NO CONNECTION

v_{ss} [7

ELECTRICAL CHARACTERISTICS	3 (Voltages Referenced to V _{SS})
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				– 55°C 25°C			125°C				
Characteristic		Symbol	V _{DD} Vdc	Min	Max	Min	Typ (Note 2)	Max	Min	Max	Unit
Output Voltage V _{in} = V _{DD} or 0	"0" Level	V _{OL}	5.0 10 15	- - -	0.05 0.05 0.05	- - -	0 0 0	0.05 0.05 0.05	- - -	0.05 0.05 0.05	Vdc
$V_{in} = 0 \text{ or } V_{DD}$	"1" Level	V _{OH}	5.0 10 15	4.95 9.95 14.95	- - -	4.95 9.95 14.95	5.0 10 15	- -	4.95 9.95 14.95	_ _ _	Vdc
Input Voltage $(V_O = 4.5 \text{ or } 0.5 \text{ Vdc})$ $(V_O = 9.0 \text{ or } 1.0 \text{ Vdc})$ $(V_O = 13.5 \text{ or } 1.5 \text{ Vdc})$	"0" Level	V _{IL}	5.0 10 15	- - -	1.5 3.0 4.0	_ _ _	2.25 4.50 6.75	1.5 3.0 4.0	_ _ _	1.5 3.0 4.0	Vdc
$(V_O = 0.5 \text{ or } 4.5 \text{ Vdc})$ $(V_O = 1.0 \text{ or } 9.0 \text{ Vdc})$ $(V_O = 1.5 \text{ or } 13.5 \text{ Vdc})$	"1" Level	V _{IH}	5.0 10 15	3.5 7.0 11	- - -	3.5 7.0 11	2.75 5.50 8.25		3.5 7.0 11		Vdc
$\begin{array}{l} \text{Output Drive Current} \\ (\text{V}_{\text{OH}} = 2.5 \ \text{Vdc}) \\ (\text{V}_{\text{OH}} = 4.6 \ \text{Vdc}) \\ (\text{V}_{\text{OH}} = 9.5 \ \text{Vdc}) \\ (\text{V}_{\text{OH}} = 13.5 \ \text{Vdc}) \end{array}$	Source	I _{OH}	5.0 5.0 10 15	-3.0 -0.64 -1.6 -4.2	- - -	-2.4 -0.51 -1.3 -3.4	-4.2 -0.88 -2.25 -8.8		-1.7 -0.36 -0.9 -2.4		mAdc
(V _{OL} = 0.4 Vdc) (V _{OL} = 0.5 Vdc) (V _{OL} = 1.5 Vdc)	Sink	I _{OL}	5.0 10 15	0.64 1.6 4.2	- - -	0.51 1.3 3.4	0.88 2.25 8.8		0.36 0.9 2.4	- - -	mAdc
Input Current		l _{in}	15	_	±0.1	_	±0.00001	±0.1	_	±1.0	μAdc
Input Capacitance (V _{in} = 0)		C _{in}	-	-	-	-	5.0	7.5	-	-	pF
Quiescent Current (Per Package)		I _{DD}	5.0 10 15	- - -	0.25 0.5 1.0	- - -	0.0005 0.0010 0.0015	0.25 0.5 1.0	- - -	7.5 15 30	μAdc
Total Supply Current (Note (Dynamic plus Quiesce Per Gate, C _L = 50 pF)		Ι _Τ	5.0 10 15		1	$I_{T} = (0.$	3 μΑ/kHz) f - 6 μΑ/kHz) f - 9 μΑ/kHz) f -	IDD/N	1		μAdc

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.
The formulas given are for the typical characteristics only at 25°C.

4. To calculate total supply current at loads other than 50 pF:

 $I_T(C_L) = I_T(50 \text{ pF}) + (C_L - 50) \text{ Vfk}$

where: I_T is in µA (per package), C_L in pF, V = (V_{DD} - V_{SS}) in volts, f in kHz is input frequency, and k = 0.001 x the number of exercised gates per package.

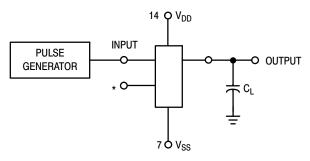
B-SERIES GATE SWITCHING TIMES

SWITCHING CHARACTERISTICS (Note 5) (C_L = 50 pF, T_A = 25° C)

Characteristic	Symbol	V _{DD} Vdc	Min	Typ (Note 6)	Мах	Unit
Output Rise Time, All B-Series Gates	t _{TLH}					ns
t _{TLH} = (1.35 ns/pF) C _L + 33 ns		5.0	_	100	200	
t _{TLH} = (0.60 ns/pF) C _L + 20 ns		10	_	50	100	
t _{TLH} = (0.40 ns/PF) C _L + 20 ns		15	-	40	80	
Output Fall Time, All B-Series Gates	t _{THL}					ns
t _{THL} = (1.35 ns/pF) C _L + 33 ns		5.0	_	100	200	
t _{THL} = (0.60 ns/pF) C _L + 20 ns		10	_	50	100	
t _{THL} = (0.40 ns/pF) C _L + 20 ns		15	-	40	80	
Propagation Delay Time	t _{PLH} , t _{PHL}					ns
MC14001B, MC14011B only						
t _{PLH} , t _{PHL} = (0.90 ns/pF) C _L + 80 ns		5.0	-	125	250	
t _{PLH} , t _{PHL} = (0.36 ns/pF) C _L + 32 ns		10	-	50	100	
t _{PLH} , t _{PHL} = (0.26 ns/pF) C _L + 27 ns		15	_	40	80	
All Other 2, 3, and 4 Input Gates						
t _{PLH} , t _{PHL} = (0.90 ns/pF) C _L + 115 ns		5.0	-	160	300	
t _{PLH} , t _{PHL} = (0.36 ns/pF) C _L + 47 ns		10	-	65	130	
t _{PLH} , t _{PHL} = (0.26 ns/pF) C _L + 37 ns		15	-	50	100	
8–Input Gates (MC14068B, MC14078B)						
t _{PLH} , t _{PHL} = (0.90 ns/pF) C _L + 155 ns		5.0	-	200	350	
t _{PLH} , t _{PHL} = (0.36 ns/pF) C _L + 62 ns		10	-	80	150	
t_{PLH} , t_{PHL} = (0.26 ns/pF) C _L + 47 ns		15	-	60	110	

5. The formulas given are for the typical characteristics only at 25°C.

6. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.



*All unused inputs of AND, NAND gates must be connected to V_{DD} . All unused inputs of OR, NOR gates must be connected to V_{SS} .

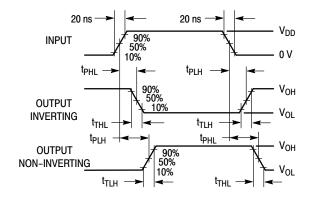
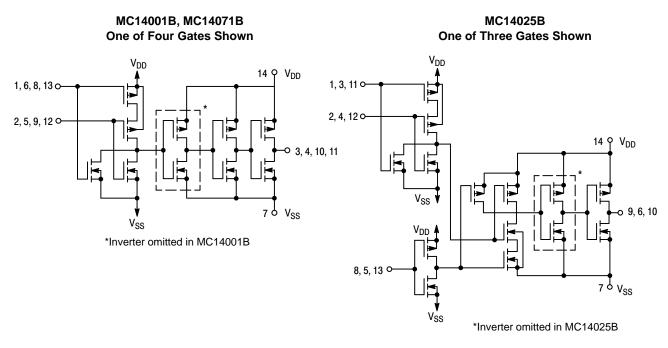
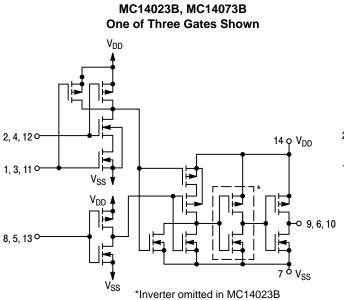


Figure 1. Switching Time Test Circuit and Waveforms

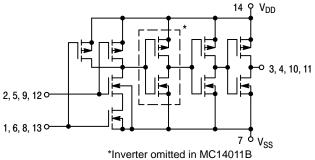
CIRCUIT SCHEMATIC NOR, OR GATES



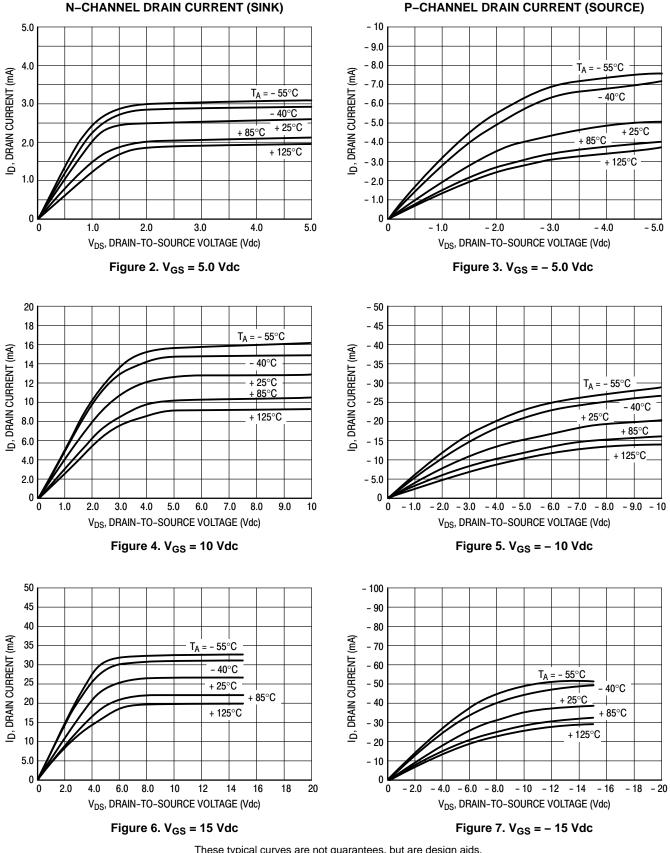
CIRCUIT SCHEMATIC NAND, AND GATES



MC14011B, MC14081B One of Four Gates Shown



TYPICAL B-SERIES GATE CHARACTERISTICS



These typical curves are not guarantees, but are design aids. Caution: The maximum rating for output current is 10 mA per pin.

TYPICAL B-SERIES GATE CHARACTERISTICS (cont'd)



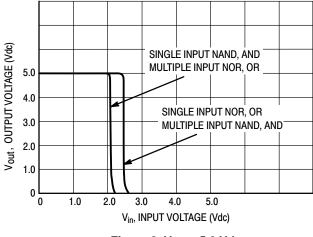


Figure 8. V_{DD} = 5.0 Vdc

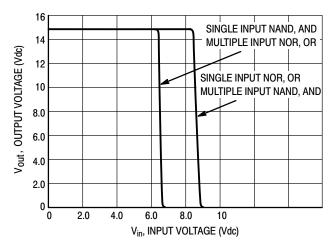
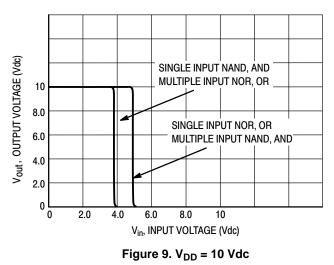


Figure 10. V_{DD} = 15 Vdc



DC NOISE MARGIN

The DC noise margin is defined as the input voltage range from an ideal "1" or "0" input level which does not produce output state change(s). The typical and guaranteed limit values of the input values V_{IL} and V_{IH} for the output(s) to be at a fixed voltage V_O are given in the Electrical Characteristics table. V_{IL} and V_{IH} are presented graphically in Figure 11.

Guaranteed minimum noise margins for both the "1" and "0" levels =

1.0 V with a 5.0 V supply 2.0 V with a 10.0 V supply 2.5 V with a 15.0 V supply

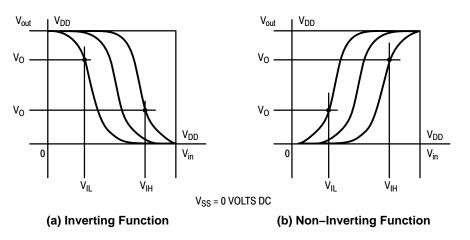


Figure 11. DC Noise Immunity

ORDERING INFORMATION

Device	Package	Shipping [†]		
MC14001BDG	SOIC-14			
NLV14001BDG*	(Pb-Free)	55 Units / Rail		
MC14001BDR2G	SOIC-14			
NLV14001BDR2G*	(Pb-Free)			
MC14001BDTR2G	TSSOP-14	2500 Units / Tape & Reel		
NLV14001BDTR2G*	(Pb-Free)			
MC14001BFELG	SOEIAJ-14 (Pb-Free)	2000 Units / Tape & Reel		
MC14011BDG	SOIC-14			
NLV14011BDG*	(Pb-Free)	55 Units / Rail		
MC14011BDR2G	SOIC-14			
NLV14011BDR2G*	(Pb-Free)			
MC14011BDTR2G	TSSOP-14	2500 Units / Tape & Reel		
NLV14011BDTR2G*	(Pb-Free)			
MC14011BFG	SOEIAJ-14	50 Units / Rail		
MC14011BFELG	(Pb-Free)	2000 Units / Tape & Reel		
MC14023BDG	SOIC-14 (Pb-Free)	55 Units / Rail		
MC14023BDR2G	SOIC-14			
NLV14023BDR2G*	(Pb-Free)	2500 Units / Tape & Reel		
MC14023BFELG	SOEIAJ-14 (Pb-Free)	2000 Units / Tape & Reel		
MC14025BDG	SOIC-14			
NLV14025BDG*	(Pb–Free)	55 Units / Rail		
MC14025BDR2G	SOIC-14			
NLV14025BDR2G*	(Pb-Free)	2500 Units / Tape & Reel		
MC14071BDG	SOIC-14			
NLV14071BDG*	(Pb–Free)	55 Units / Rail		
MC14071BDR2G	SOIC-14			
NLV14071BDR2G*	(Pb–Free)	2500 Units / Tape & Reel		
MC14071BDTG		96 Units per Rail		
MC14071BDTR2G	TSSOP-14 (Pb-Free)			
NLV14071BDTR2G*	(FD-FIGG)	2500 Units / Tape & Reel		
MC14073BDG	SOIC-14			
	(Pb–Free)	55 Units / Rail		
MC14073BDR2G	SOIC–14 (Pb–Free)	2500 Units / Tape & Reel		
	(

ORDERING INFORMATION (continued)

Device	Package	Shipping [†]	
MC14081BDG	SOIC-14		
NLV14081BDG*	(Pb-Free)	55 Units / Rail	
MC14081BDR2G	SOIC-14		
NLV14081BDR2G*	(Pb-Free)		
MC14081BDTR2G	TSSOP-14	2500 Units / Tape & Reel	
NLV14081BDTR2G*	(Pb-Free)		

MC14082BDG		55 Units / Rail	
NLV14082BDG*	SOIC–14 (Pb–Free)		
MC14082BDR2G	· · · /	2500 Units / Tape & Reel	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

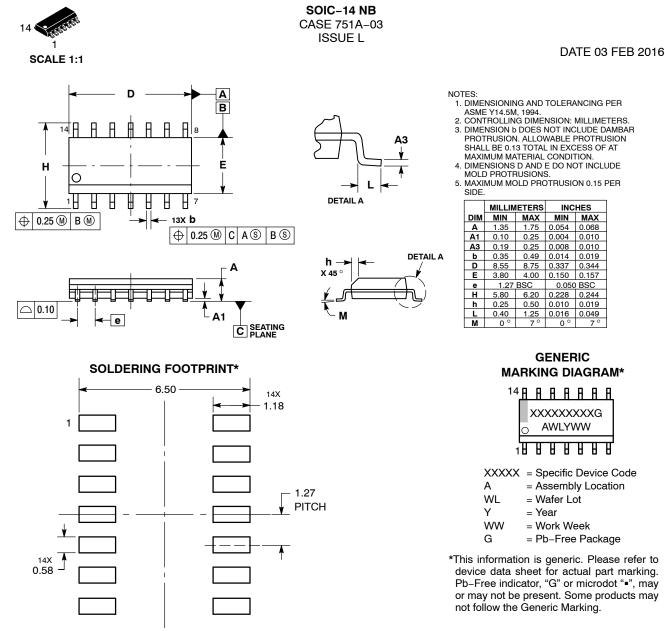
*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP Capable.

DUSEM

0.068

0.019

0.344



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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SOIC-14 CASE 751A-03 ISSUE L

DATE 03 FEB 2016

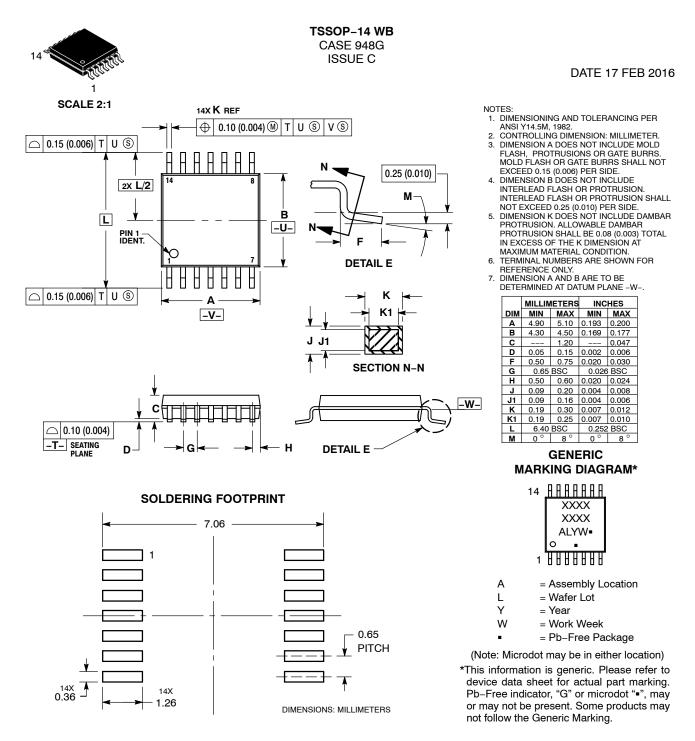
STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 2: CANCELLED	STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 8. CATHODE 9. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE	STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANDDE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. ANODE/CATHODE 7. ANODE/CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON ANODE 13. ANODE/CATHODE 14. ANODE/CATHODE	STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 8. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE

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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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